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MBR2035CT - MBR2060CT

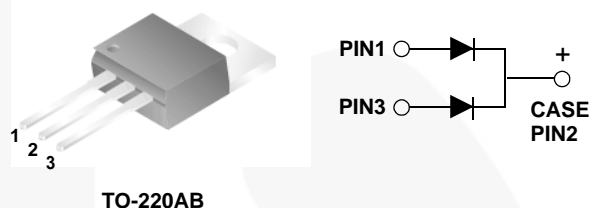
20 A Schottky Barrier Rectifiers

Features

- Low Power Loss, High Efficiency
- High Surge Capacity
- Metal Silicon Junction, Majority Carrier Conduction
- High Current Capacity, Low Forward Voltage Drop
- Guard Ring for Over-Voltage Protection (OVP)

Applications

- Low-Voltage, High-Frequency Inverters
- Free Wheeling and Polarity Protection



Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value				Units
		2035CT	2045CT	2050CT	2060CT	
V_{RRM}	Maximum Repetitive Reverse Voltage	35	45	50	60	V
$I_{F(AV)}$	Average Rectified Forward Current .375 inch Lead Length at $T_A = 135^\circ\text{C}$	20				A
I_{FSM}	Non-Repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	150				A
T_{STG}	Storage Temperature Range	-65 to +175				$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-65 to +150				$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	2.0	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	60	$^\circ\text{C}/\text{W}$
$R_{\theta JL}$	Thermal Resistance, Junction to Lead	2.0	$^\circ\text{C}/\text{W}$

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value				Units
		2035CT	2045CT	2050CT	2060CT	
V_F	Maximum Forward Voltage, per Leg	$I_F = 10\text{ A}, T_C = 25^\circ\text{C}$			0.80	V
		$I_F = 10\text{ A}, T_C = 125^\circ\text{C}$	0.57		0.70	
		$I_F = 20\text{ A}, T_C = 25^\circ\text{C}$	0.84		0.95	
		$I_F = 20\text{ A}, T_C = 125^\circ\text{C}$	0.72		0.85	
I_R	Maximum Reverse Current at Rated V_{RRM} , per Leg	$T_A = 25^\circ\text{C}$	0.10		0.15	mA
		$T_A = 125^\circ\text{C}$	15		150	
I_{RRM}	Peak Repetitive Reverse Surge Current, per Leg 2.0 μs Pulse Width, $f = 1.0\text{ kHz}$		1.0		0.5	A

Typical Performance Characteristics

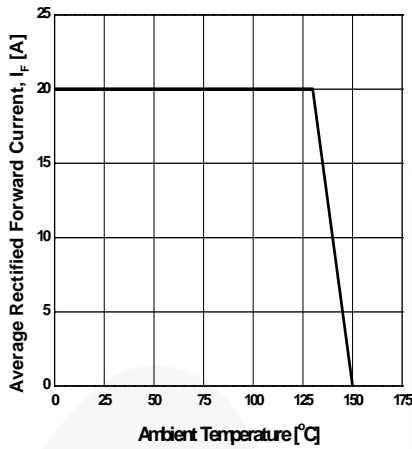


Figure 1. Forward Current Derating Curve

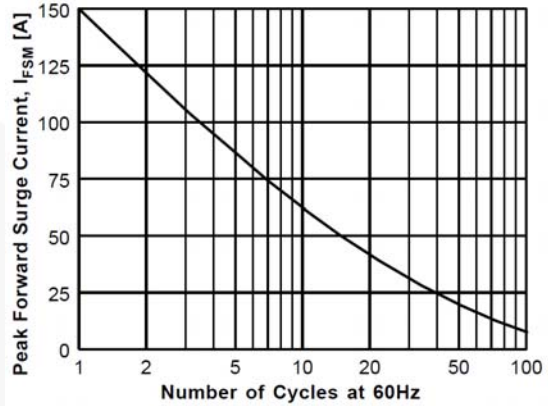


Figure 2. Non-Repetitive Surge Current

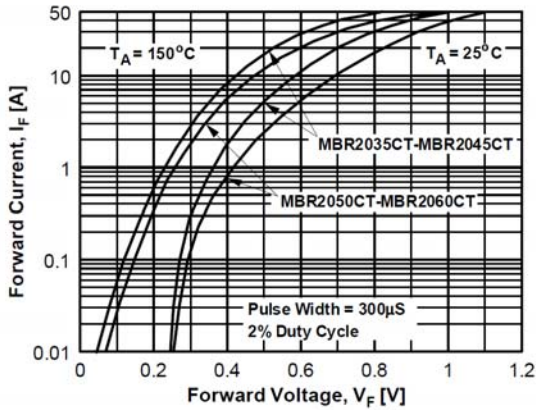


Figure 3. Forward Voltage Characteristics

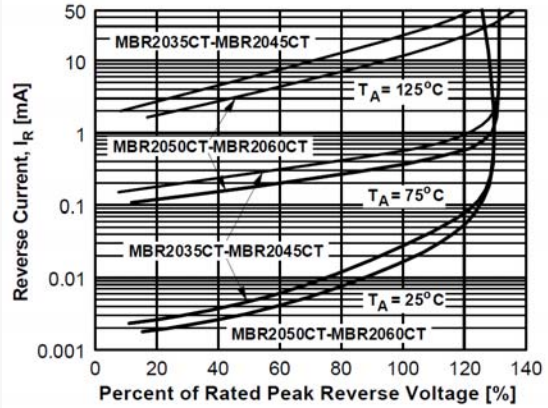


Figure 4. Reverse Current vs. Reverse Voltage

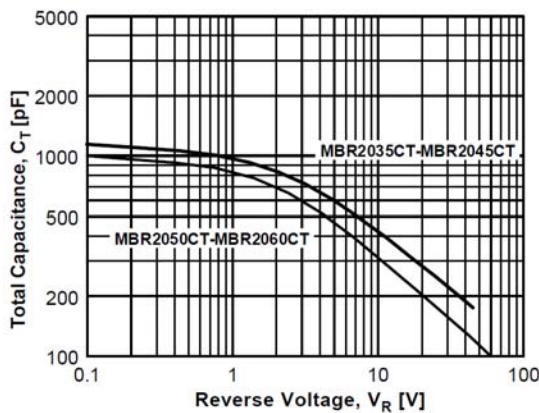


Figure 5. Total Capacitance

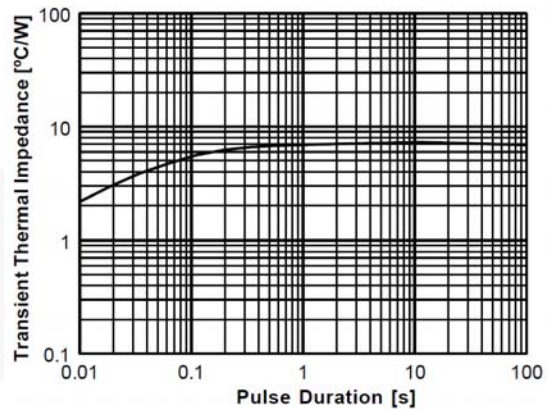


Figure 6. Thermal Impedance Characteristics

Physical Dimensions

TO-220 3L

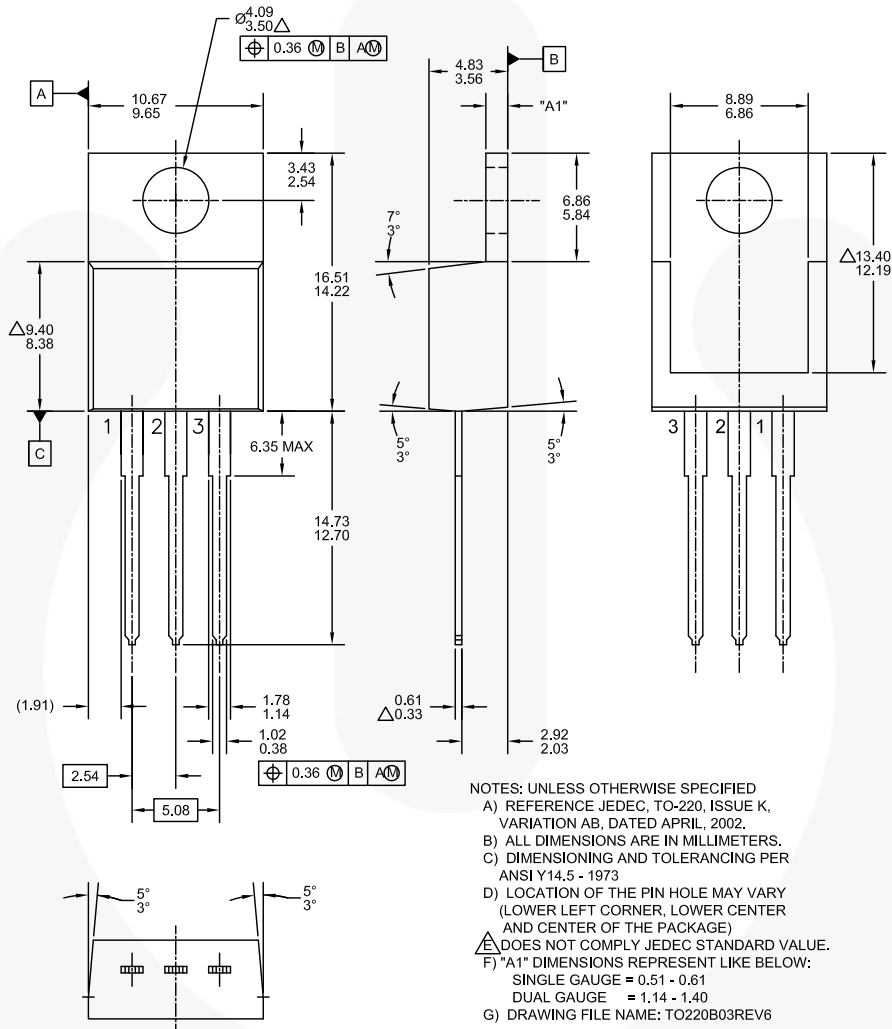


Figure 7. TO-220, MOLDED, 3-LEAD, JEDEC VARIATION AB (ACTIVE)

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
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